



BSI Standards Publication

Semiconductor devices — Mechanical and climatic test methods

Part 40: Board level drop test method
using a strain gauge

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National foreword

This British Standard is the UK implementation of EN 60749-40:2011. It is identical to IEC 60749-40:2011.

The UK participation in its preparation was entrusted to Technical Committee EPL/47, Semiconductors.

A list of organizations represented on this committee can be obtained on request to its secretary.

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ISBN 978 0 580 64629 4

ICS 31.080.01

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This British Standard was published under the authority of the Standards Policy and Strategy Committee on 30 September 2011.

Amendments issued since publication

Amd. No.	Date	Text affected
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EUROPEAN STANDARD
NORME EUROPÉENNE
EUROPÄISCHE NORM

EN 60749-40

September 2011

ICS 31.080.01

English version

**Semiconductor devices -
Mechanical and climatic test methods -
Part 40: Board level drop test method using a strain gauge
(IEC 60749-40:2011)**

Dispositifs à semiconducteurs -
Méthodes d'essais mécaniques et
climatiques -
Partie 40: Méthode d'essai de chute au
niveau de la carte avec utilisation d'une
jaugé de contrainte
(CEI 60749-40:2011)

Halbleiterbauelemente -
Mechanische und klimatische
Prüfverfahren -
Teil 40: Prüfverfahren zum Fall einer
Leiterplatte unter Verwendung von
Dehnungsmessstreifen
(IEC 60749-40:2011)

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CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

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Foreword

The text of document 47/2094/FDIS, future edition 1 of IEC 60749-40, prepared by IEC TC 47, Semiconductor devices, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60749-40 on 2011-08-17.

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The following dates were fixed:

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| – latest date by which the EN has to be implemented
at national level by publication of an identical
national standard or by endorsement | (dop) | 2012-05-17 |
| – latest date by which the national standards conflicting
with the EN have to be withdrawn | (dow) | 2014-08-17 |

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 60749-40:2011 was approved by CENELEC as a European Standard without any modification.
